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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	752
Number of Logic Elements/Cells	6768
Total RAM Bits	516096
Number of I/O	248
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp4-5fg456i

ing character, and remembers its location in the buffer. At some point, one transceiver designated as the master instructs all the transceivers to align to the channel bonding character "P" (or to some location relative to the channel bonding character).

After this operation, words transmitted to the FPGA fabric are properly aligned: RRRR, SSSS, TTTT, and so forth, as shown in the bottom-right portion of Figure 7. To ensure that the channels remain properly aligned following the channel bonding operation, the master transceiver must also control the clock correction operations described in the previous section for all channel-bonded transceivers.

Transmitter Buffer

The transmitter's buffer write pointer (TXUSRCLK) is frequency-locked to its read pointer (REFCLK). Therefore, clock correction and channel bonding are not required. The purpose of the transmitter's buffer is to accommodate a phase difference between TXUSRCLK and REFCLK. A simple FIFO suffices for this purpose. A FIFO depth of four will permit reliable operation with simple detection of overflow or underflow, which could occur if the clocks are not frequency-locked.

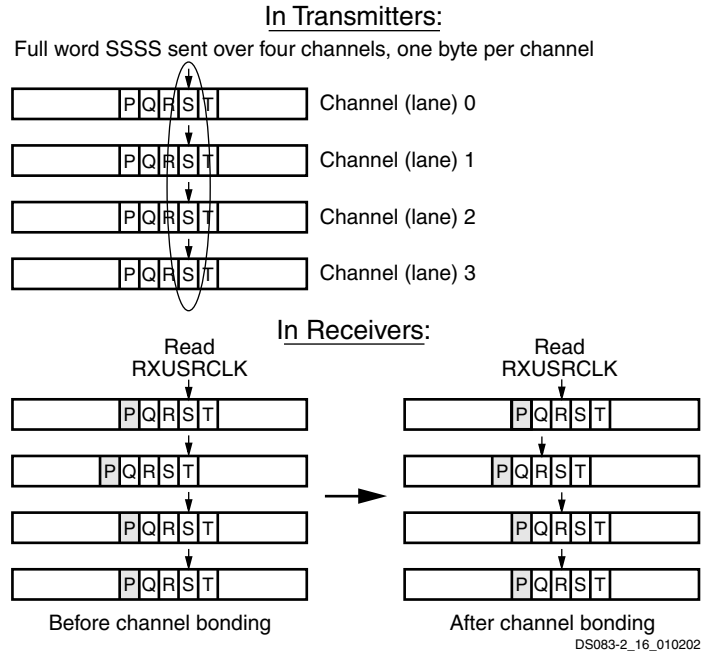


Figure 7: Channel Bonding (Alignment)

RocketIO X Configuration

This section outlines functions that can be selected or controlled by configuration. Xilinx implementation software supports the transceiver primitives shown in Table 3.

Table 3: Supported RocketIO X Transceiver Primitives

Primitive	Description
GT10_CUSTOM	Fully customizable by user
GT10_OC48_1	SONET OC-48, 1-byte data path
GT10_OC48_2	SONET OC-48, 2-byte data path
GT10_OC48_4	SONET OC-48, 4-byte data path
GT10_PCI_EXPRESS_1	PCI Express, 1-byte data path
GT10_PCI_EXPRESS_2	PCI Express, 2-byte data path
GT10_PCI_EXPRESS_4	PCI Express, 4-byte data path
GT10_INFINIBAND_1	Infiniband, 1-byte data path
GT10_INFINIBAND_2	Infiniband, 2-byte data path
GT10_INFINIBAND_4	Infiniband, 4-byte data path

Figure 30 provides examples illustrating the use of the LVDS_25_DCI and LVDSEXT_25_DCI I/O standards. For a complete list, see the [Virtex-II Pro Platform FPGA User Guide](#).

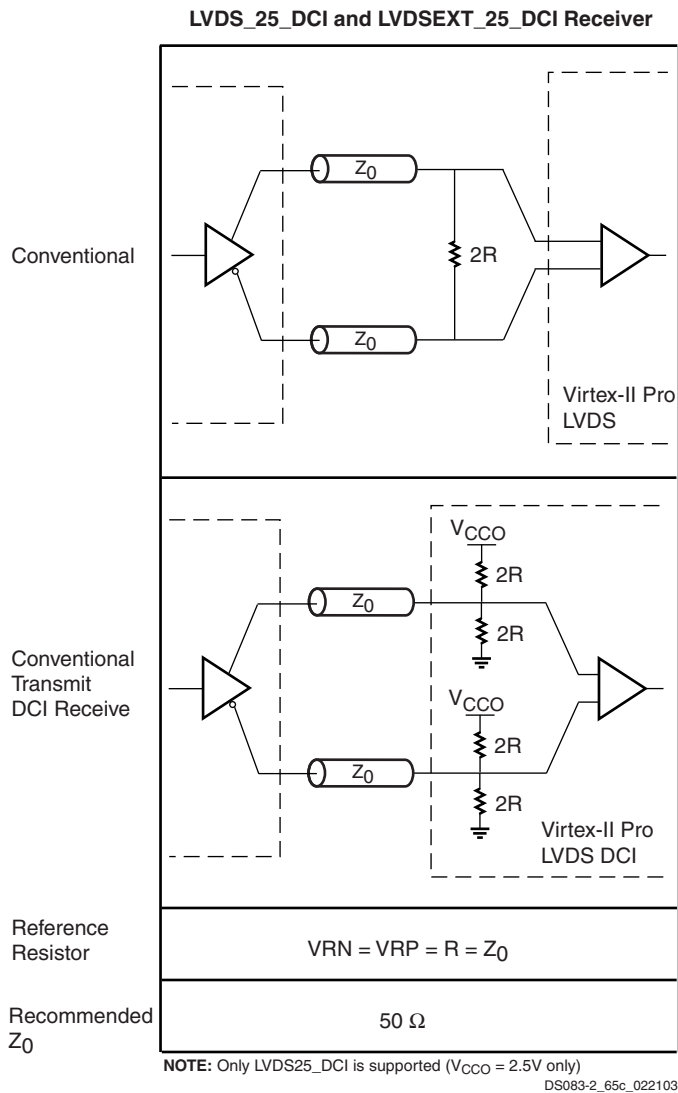


Figure 30: LVDS DCI Usage Examples

On-Chip Differential Termination

Virtex-II Pro provides a true $100\ \Omega$ differential termination (DT) across the input differential receiver terminals. The LVDS_25_DT, LVDSEXT_25_DT, LDT_25_DT, and ULVDS_25_DT standards support on-chip differential termination.

The on-chip input differential termination in Virtex-II Pro provides major advantages over the external resistor or the DCI termination solution:

- Eliminates the stub at the receiver completely and therefore greatly improve signal integrity
- Consumes less power than DCI termination
- Supports LDT (not supported by DCI termination)
- Frees up VRP/VRN pins

Figure 31 provides examples illustrating the use of the LVDS_25_DT, LVDSEXT_25_DT, LDT_25_DT, and ULVDS_25_DT I/O standards. For further details, refer to [Solution Record 17244](#). Also see the [Virtex-II Pro Platform FPGA User Guide](#) for more design information.

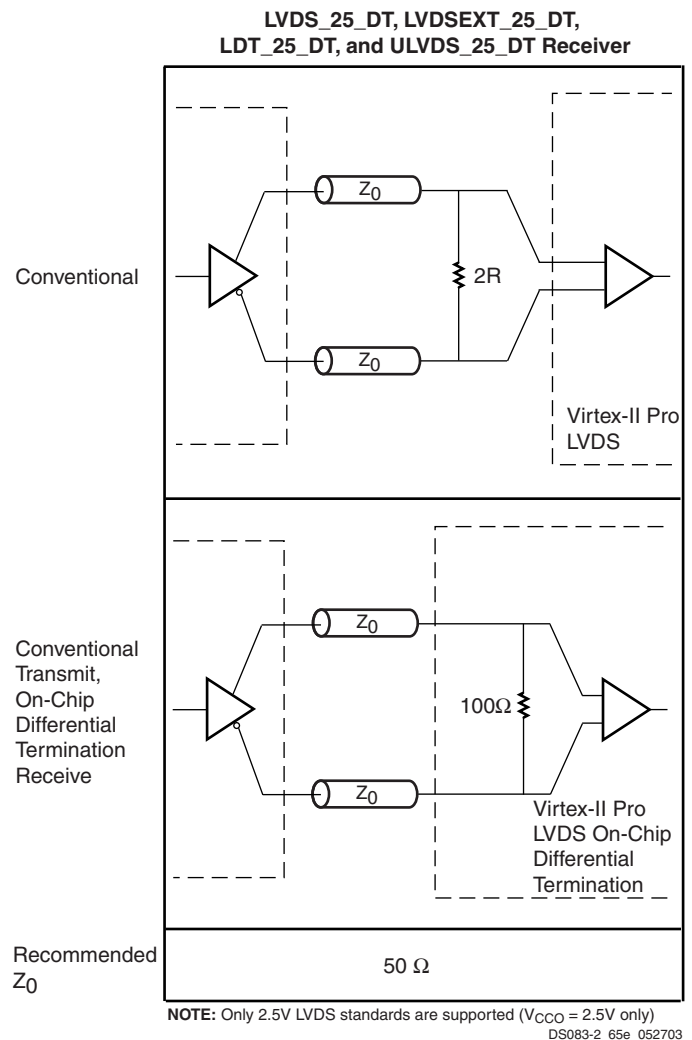
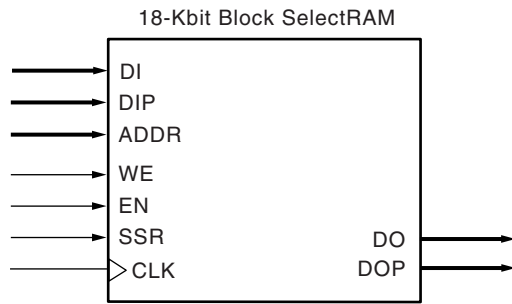


Figure 31: LVDS Differential Termination Usage Examples

nally in user logic. In such cases, the width is viewed as 8 + 1, 16 + 2, or 32 + 4. These extra parity bits are stored and behave exactly as the other bits, including the timing parameters. Video applications can use the 9-bit ratio of Virtex-II Pro block SelectRAM+ memory to advantage.

Each block SelectRAM+ cell is a fully synchronous memory as illustrated in **Figure 47**. Input data bus and output data bus widths are identical.



DS031_10_102000

Figure 47: 18 Kb Block SelectRAM+ Memory in Single-Port Mode

Dual-Port Configuration

As a dual-port RAM, each port of block SelectRAM+ has access to a common 18 Kb memory resource. These are fully synchronous ports with independent control signals for each port. The data widths of the two ports can be configured independently, providing built-in bus-width conversion.

Table 22 illustrates the different configurations available on ports A and B.

If both ports are configured in either 2K x 9-bit, 1K x 18-bit, or 512 x 36-bit configurations, the 18 Kb block is accessible from port A or B. If both ports are configured in either 16K x 1-bit, 8K x 2-bit, or 4K x 4-bit configurations, the 16 K-bit block is accessible from Port A or Port B. All other configurations result in one port having access to an 18 Kb memory block and the other port having access to a 16 K-bit subset of the memory block equal to 16 Kbs.

Table 22: Dual-Port Mode Configurations

Port A	16K x 1	16K x 1	16K x 1	16K x 1	16K x 1	16K x 1
Port B	16K x 1	8K x 2	4K x 4	2K x 9	1K x 18	512 x 36
Port A	8K x 2	8K x 2	8K x 2	8K x 2	8K x 2	
Port B	8K x 2	4K x 4	2K x 9	1K x 18	512 x 36	
Port A	4K x 4	4K x 4	4K x 4	4K x 4		
Port B	4K x 4	2K x 9	1K x 18	512 x 36		
Port A	2K x 9	2K x 9	2K x 9			
Port B	2K x 9	1K x 18	512 x 36			
Port A	1K x 18	1K x 18				
Port B	1K x 18	512 x 36				
Port A	512 x 36					
Port B	512 x 36					

Table 35: IOB Input Switching Characteristics (Continued)

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
Setup and Hold Times With Respect to Clock at IOB Input Register						
Pad, no delay	$T_{IOIPICK}/T_{IOICKP}$	All	0.84/−0.61	0.86/−0.63	0.90/−0.67	ns, min
Pad, with delay	$T_{IOIPICKD}/T_{IOICKPD}$	XC2VP2	2.28/−1.89	2.60/−2.15	2.95/−2.43	ns, max
		XC2VP4	2.55/−2.10	2.87/−2.36	3.21/−2.65	ns, max
		XC2VP7	2.48/−2.05	2.82/−2.32	3.15/−2.60	ns, max
		XC2VP20	2.63/−2.05	3.02/−2.35	3.40/−2.66	ns, max
		XC2VPX20	2.63/−2.05	3.02/−2.35	3.40/−2.66	ns, max
		XC2VP30	2.67/−2.07	3.09/−2.42	3.49/−2.73	ns, max
		XC2VP40	3.28/−2.56	3.61/−2.83	4.01/−3.15	ns, max
		XC2VP50	3.84/−3.02	4.08/−3.21	4.42/−3.48	ns, max
		XC2VP70	3.98/−3.13	4.23/−3.33	4.55/−3.58	ns, max
		XC2VPX70	3.98/−3.13	4.23/−3.33	4.55/−3.58	ns, max
	XC2VP100	N/A	6.48/−5.13	7.04/−5.57	ns, max	
ICE input	$T_{IOICECK}/T_{IOCKICE}$	All	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
SR input (IFF, synchronous)	$T_{IOSRCKI}$	All	0.52	0.57	0.75	ns, min
Set/Reset Delays						
SR input to IQ (asynchronous)	T_{IOSRIQ}	All	1.13	1.27	1.42	ns, max
GSR to output IQ	T_{GSRQ}	All	5.87	6.75	7.43	ns, max

Notes:

1. Input timing for LVCMOS25 is measured at 1.25V. For other I/O standards, see [Table 39](#).

IOB Output Switching Characteristics

Output delays terminating at a pad are specified for LVCMOS25 with 12 mA drive and fast slew rate. For other standards, adjust the delays with the values shown in [IOB Output Switching Characteristics Standard Adjustments](#).

Table 37: IOB Output Switching Characteristics

		Speed Grade			
Description	Symbol	-7	-6	-5	Units
Propagation Delays					
O input to Pad	T _{IOOP}	1.58	1.68	1.85	ns, max
O input to Pad via transparent latch	T _{IOOLP}	1.65	1.82	1.99	ns, max
3-State Delays					
T input to Pad high-impedance ⁽²⁾	T _{IOTHZ}	1.23	1.35	1.51	ns, max
T input to valid data on Pad	T _{IOTP}	1.51	1.63	1.78	ns, max
T input to Pad high-impedance via transparent latch ⁽²⁾	T _{IOTLPHZ}	1.08	1.22	1.36	ns, max
T input to valid data on Pad via transparent latch	T _{IOTLPON}	1.56	1.69	1.85	ns, max
GTS to Pad high-impedance ⁽²⁾	T _{GTS}	4.11	4.73	5.20	ns, max
Sequential Delays					
Clock CLK to Pad	T _{IOCKP}	1.59	1.76	1.93	ns, max
Clock CLK to Pad high-impedance (synchronous) ⁽²⁾	T _{IOCKHZ}	1.39	1.55	1.73	ns, max
Clock CLK to valid data on Pad (synchronous)	T _{IOCKON}	1.67	1.82	2.00	ns, max
Setup and Hold Times Before/After Clock CLK					
O input	T _{IOOCK} /T _{IOCKO}	0.23/ 0.12	0.26/ 0.14	0.29/ 0.15	ns, min
OCE input	T _{IOOCECK} /T _{IOCKOCE}	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
SR input (OFF)	T _{IOSRCKO} /T _{IOCKOSR}	0.52/ 0.00	0.57/ 0.00	0.75/ 0.00	ns, min
3-State Setup Times, T input	T _{IOTCK} /T _{IOCKT}	0.23/ 0.12	0.26/ 0.14	0.29/ 0.15	ns, min
3-State Setup Times, TCE input	T _{IOTCECK} /T _{IOCKTCE}	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
3-State Setup Times, SR input (TFF)	T _{IOSRCKT} /T _{IOCKTSR}	0.52/ 0.00	0.57/ 0.00	0.75/ 0.00	ns, min
Set/Reset Delays					
Minimum Pulse Width, SR inputs (asynchronous)	T _{RPW}	0.37	0.40	0.45	ns, min
SR input to Pad (asynchronous)	T _{IOSRP}	2.33	2.56	2.83	ns, max
SR input to Pad high-impedance (asynchronous) ⁽²⁾	T _{IOSRHZ}	1.97	2.16	2.41	ns, max
SR input to valid data on Pad (asynchronous)	T _{IOSRON}	2.24	2.44	2.69	ns, max
GSR to Pad	T _{IOGSRQ}	5.87	6.75	7.43	ns, max

Notes:

1. A Zero "0" Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed "best-case", but if a "0" is listed, there is no positive hold time.
2. The 3-state turn-off delays should not be adjusted.

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
2	IO_L31P_2	F26			
2	IO_L32N_2	G22			
2	IO_L32P_2	H22			
2	IO_L34N_2/VREF_2	G23			
2	IO_L34P_2	G24			
2	IO_L36N_2	G25			
2	IO_L36P_2	G26			
2	IO_L37N_2	H20			
2	IO_L37P_2	H21			
2	IO_L38N_2	H25			
2	IO_L38P_2	H26			
2	IO_L40N_2/VREF_2	J19			
2	IO_L40P_2	J20			
2	IO_L42N_2	J21			
2	IO_L42P_2	J22			
2	IO_L43N_2	J23			
2	IO_L43P_2	J24			
2	IO_L44N_2	J25			
2	IO_L44P_2	J26			
2	IO_L46N_2/VREF_2	K19			
2	IO_L46P_2	L19			
2	IO_L48N_2	K22			
2	IO_L48P_2	K23			
2	IO_L49N_2	K24			
2	IO_L49P_2	L24			
2	IO_L50N_2	K25			
2	IO_L50P_2	K26			
2	IO_L52N_2/VREF_2	L20			
2	IO_L52P_2	M20			
2	IO_L54N_2	L21			
2	IO_L54P_2	L22			
2	IO_L55N_2	L25			
2	IO_L55P_2	L26			
2	IO_L56N_2	M18			
2	IO_L56P_2	M19			

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
3	VCCO_3	AB24			
4	VCCO_4	U14			
4	VCCO_4	U15			
4	VCCO_4	V16			
4	VCCO_4	V17			
4	VCCO_4	AC16			
4	VCCO_4	AD19			
4	VCCO_4	AD22			
5	VCCO_5	U12			
5	VCCO_5	U13			
5	VCCO_5	V10			
5	VCCO_5	V11			
5	VCCO_5	AC11			
5	VCCO_5	AD5			
5	VCCO_5	AD8			
6	VCCO_6	P10			
6	VCCO_6	R10			
6	VCCO_6	T4			
6	VCCO_6	T9			
6	VCCO_6	U9			
6	VCCO_6	W3			
6	VCCO_6	AB3			
7	VCCO_7	E3			
7	VCCO_7	H3			
7	VCCO_7	K9			
7	VCCO_7	L4			
7	VCCO_7	L9			
7	VCCO_7	M10			
7	VCCO_7	N10			
N/A	PROG_B	B1			
N/A	HSWAP_EN	B3			
N/A	DXP	A3			
N/A	DXN	C4			
N/A	AVCCAUXTX4	B5			

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
N/A	GND	H4			
N/A	GND	H23			
N/A	GND	K6			
N/A	GND	K21			
N/A	GND	L11			
N/A	GND	L12			
N/A	GND	L13			
N/A	GND	L14			
N/A	GND	L15			
N/A	GND	L16			
N/A	GND	M3			
N/A	GND	M11			
N/A	GND	M12			
N/A	GND	M13			
N/A	GND	M14			
N/A	GND	M15			
N/A	GND	M16			
N/A	GND	M24			
N/A	GND	N11			
N/A	GND	N12			
N/A	GND	N13			
N/A	GND	N14			
N/A	GND	N15			
N/A	GND	N16			
N/A	GND	P11			
N/A	GND	P12			
N/A	GND	P13			
N/A	GND	P14			
N/A	GND	P15			
N/A	GND	P16			
N/A	GND	R3			
N/A	GND	R11			
N/A	GND	R12			
N/A	GND	R13			
N/A	GND	R14			

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
7	VCCO_7	T23				
7	VCCO_7	U23				
N/A	CCLK	AE9				
N/A	PROG_B	J26				
N/A	DONE	AE10				
N/A	M0	AF26				
N/A	M1	AE26				
N/A	M2	AE25				
N/A	TCK	J9				
N/A	TDI	H28				
N/A	TDO	H7				
N/A	TMS	K10				
N/A	PWRDWN_B	AF9				
N/A	HSWAP_EN	K25				
N/A	RSVD	G8				
N/A	VBATT	K9				
N/A	DXP	K26				
N/A	DXN	G27				
N/A	AVCCAUXTX2	B32	NC	NC		
N/A	VTTXPAD2	B33	NC	NC		
N/A	TXNPAD2	A33	NC	NC		
N/A	TXPPAD2	A32	NC	NC		
N/A	GND A2	C30	NC	NC		
N/A	RXPPAD2	A31	NC	NC		
N/A	RXNPAD2	A30	NC	NC		
N/A	VTRXPAD2	B31	NC	NC		
N/A	AVCCAUXRX2	B30	NC	NC		
N/A	AVCCAUXTX4	B28				
N/A	VTTXPAD4	B29				
N/A	TXNPAD4	A29				
N/A	TXPPAD4	A28				
N/A	GND A4	C27				
N/A	RXPPAD4	A27				
N/A	RXNPAD4	A26				
N/A	VTRXPAD4	B27				
N/A	AVCCAUXRX4	B26				
N/A	AVCCAUXTX5	B24	NC	NC	NC	

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
4	IO_L47N_4	AE15		
4	IO_L47P_4	AD15		
4	IO_L48N_4	AM14		
4	IO_L48P_4	AL14		
4	IO_L49N_4	AP14		
4	IO_L49P_4	AN14		
4	IO_L50_4/No_Pair	AH15		
4	IO_L53_4/No_Pair	AG16		
4	IO_L54N_4	AK15		
4	IO_L54P_4	AJ15		
4	IO_L55N_4	AM15		
4	IO_L55P_4	AL16		
4	IO_L56N_4	AE16		
4	IO_L56P_4	AD16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AN15		
4	IO_L66N_4	AJ16	NC	
4	IO_L66P_4/VREF_4	AH16	NC	
4	IO_L67N_4	AN16		
4	IO_L67P_4	AM16		
4	IO_L68N_4	AG17		
4	IO_L68P_4	AF17		
4	IO_L69N_4	AJ17		
4	IO_L69P_4/VREF_4	AH17		
4	IO_L73N_4	AL17		
4	IO_L73P_4	AK17		
4	IO_L74N_4/GCLK3S	AE17		
4	IO_L74P_4/GCLK2P	AD17		
4	IO_L75N_4/GCLK1S	AN17		
4	IO_L75P_4/GCLK0P	AM17		
5	IO_L75N_5/GCLK7S	AM18		
5	IO_L75P_5/GCLK6P	AN18		
5	IO_L74N_5/GCLK5S	AD18		
5	IO_L74P_5/GCLK4P	AE18		
5	IO_L73N_5	AK18		
5	IO_L73P_5	AL18		
5	IO_L69N_5/VREF_5	AH18		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
6	IO_L44N_6	AA28		
6	IO_L45P_6	AC31		
6	IO_L45N_6/VREF_6	AC32		
6	IO_L46P_6	AC29		
6	IO_L46N_6	AC30		
6	IO_L47P_6	AA24		
6	IO_L47N_6	AA25		
6	IO_L48P_6	AB32		
6	IO_L48N_6	AB33		
6	IO_L49P_6	AB28		
6	IO_L49N_6	AB29		
6	IO_L50P_6	AA26		
6	IO_L50N_6	Y26		
6	IO_L51P_6	AA33		
6	IO_L51N_6/VREF_6	AA34		
6	IO_L52P_6	AB31		
6	IO_L52N_6	AA31		
6	IO_L53P_6	Y24		
6	IO_L53N_6	Y25		
6	IO_L54P_6	AA29		
6	IO_L54N_6	AA30		
6	IO_L55P_6	Y33		
6	IO_L55N_6	Y34		
6	IO_L56P_6	Y28		
6	IO_L56N_6	W27		
6	IO_L57P_6	AA32		
6	IO_L57N_6/VREF_6	Y32		
6	IO_L58P_6	Y29		
6	IO_L58N_6	Y30		
6	IO_L59P_6	W24		
6	IO_L59N_6	W25		
6	IO_L60P_6	W31		
6	IO_L60N_6	W32		
6	IO_L85P_6	W28		
6	IO_L85N_6	W29		
6	IO_L86P_6	V26		
6	IO_L86N_6	V27		
6	IO_L87P_6	W33		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	VCCINT	M23		
N/A	VCCINT	AB22		
N/A	VCCINT	AA22		
N/A	VCCINT	Y22		
N/A	VCCINT	W22		
N/A	VCCINT	V22		
N/A	VCCINT	U22		
N/A	VCCINT	T22		
N/A	VCCINT	R22		
N/A	VCCINT	P22		
N/A	VCCINT	N22		
N/A	VCCINT	AB21		
N/A	VCCINT	N21		
N/A	VCCINT	AB20		
N/A	VCCINT	N20		
N/A	VCCINT	AB19		
N/A	VCCINT	N19		
N/A	VCCINT	AB18		
N/A	VCCINT	N18		
N/A	VCCINT	AB17		
N/A	VCCINT	N17		
N/A	VCCINT	AB16		
N/A	VCCINT	N16		
N/A	VCCINT	AB15		
N/A	VCCINT	N15		
N/A	VCCINT	AB14		
N/A	VCCINT	N14		
N/A	VCCINT	AB13		
N/A	VCCINT	AA13		
N/A	VCCINT	Y13		
N/A	VCCINT	W13		
N/A	VCCINT	V13		
N/A	VCCINT	U13		
N/A	VCCINT	T13		
N/A	VCCINT	R13		
N/A	VCCINT	P13		
N/A	VCCINT	N13		
N/A	VCCINT	AC12		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP19		
N/A	GND	AK19		
N/A	GND	AF19		
N/A	GND	AA19		
N/A	GND	Y19		
N/A	GND	W19		
N/A	GND	V19		
N/A	GND	U19		
N/A	GND	T19		
N/A	GND	R19		
N/A	GND	P19		
N/A	GND	J19		
N/A	GND	E19		
N/A	GND	A19		
N/A	GND	AP18		
N/A	GND	AA18		
N/A	GND	Y18		
N/A	GND	W18		
N/A	GND	V18		
N/A	GND	U18		
N/A	GND	T18		
N/A	GND	R18		
N/A	GND	P18		
N/A	GND	A18		
N/A	GND	AA17		
N/A	GND	Y17		
N/A	GND	W17		
N/A	GND	V17		
N/A	GND	U17		
N/A	GND	T17		
N/A	GND	R17		
N/A	GND	P17		
N/A	GND	AP16		
N/A	GND	AK16		
N/A	GND	AF16		
N/A	GND	AA16		
N/A	GND	Y16		
N/A	GND	W16		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
6	IO_L04P_6	AR33		
6	IO_L04N_6	AP33		
6	IO_L05P_6	AM32		
6	IO_L05N_6	AL31		
6	IO_L06P_6	AT34		
6	IO_L06N_6	AR34		
6	IO_L73P_6	AU35	NC	
6	IO_L73N_6	AT35	NC	
6	IO_L75P_6	AT38	NC	
6	IO_L75N_6/VREF_6	AT39	NC	
6	IO_L76P_6	AR37	NC	
6	IO_L76N_6	AR38	NC	
6	IO_L78P_6	AP38	NC	
6	IO_L78N_6	AP39	NC	
6	IO_L79P_6	AP36	NC	
6	IO_L79N_6	AP37	NC	
6	IO_L81P_6	AP35	NC	
6	IO_L81N_6/VREF_6	AN35	NC	
6	IO_L82P_6	AN38	NC	
6	IO_L82N_6	AN39	NC	
6	IO_L84P_6	AN36	NC	
6	IO_L84N_6	AN37	NC	
6	IO_L07P_6	AN33		
6	IO_L07N_6	AN34		
6	IO_L08P_6	AK31		
6	IO_L08N_6	AK32		
6	IO_L09P_6	AM37		
6	IO_L09N_6/VREF_6	AM38		
6	IO_L10P_6	AM36		
6	IO_L10N_6	AL35		
6	IO_L11P_6	AJ31		
6	IO_L11N_6	AH30		
6	IO_L12P_6	AM33		
6	IO_L12N_6	AM34		
6	IO_L13P_6	AL38		
6	IO_L13N_6	AL39		
6	IO_L14P_6	AH29		
6	IO_L14N_6	AG29		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	VCCAUX	AP6		
N/A	VCCAUX	F6		
N/A	VCCAUX	AR5		
N/A	VCCAUX	E5		
N/A	VCCAUX	AW2		
N/A	VCCAUX	Y2		
N/A	VCCAUX	A2		
N/A	VCCAUX	AV1		
N/A	VCCAUX	AA1		
N/A	VCCAUX	Y1		
N/A	VCCAUX	W1		
N/A	VCCAUX	B1		
N/A	GND	A3		
N/A	GND	AV2		
N/A	GND	AU2		
N/A	GND	AA2		
N/A	GND	W2		
N/A	GND	C2		
N/A	GND	B2		
N/A	GND	AU1		
N/A	GND	AM1		
N/A	GND	AH1		
N/A	GND	AD1		
N/A	GND	T1		
N/A	GND	M1		
N/A	GND	H1		
N/A	GND	C1		
N/A	GND	AD5		
N/A	GND	T5		
N/A	GND	M5		
N/A	GND	H5		
N/A	GND	AU4		
N/A	GND	AT4		
N/A	GND	D4		
N/A	GND	C4		
N/A	GND	AW3		
N/A	GND	AV3		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
3	IO_L77N_3		AT3		
3	IO_L77P_3		AT4		
3	IO_L76N_3		AU1		
3	IO_L76P_3		AU2		
3	IO_L75N_3/VREF_3		AU3		
3	IO_L75P_3		AU4		
3	IO_L74N_3		AV3		
3	IO_L74P_3		AW3		
3	IO_L73N_3		AV1		
3	IO_L73P_3		AV2		
3	IO_L06N_3		AW1		
3	IO_L06P_3		AW2		
3	IO_L05N_3		AT8		
3	IO_L05P_3		AU8		
3	IO_L04N_3		AT6		
3	IO_L04P_3		AU7		
3	IO_L03N_3/VREF_3		AY5		
3	IO_L03P_3		AY6		
3	IO_L02N_3		AV7		
3	IO_L02P_3		AW7		
3	IO_L01N_3/VRP_3		AV6		
3	IO_L01P_3/VRN_3		AW6		
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾		AT9		
4	IO_L01P_4/INIT_B		AR9		
4	IO_L02N_4/D0/DIN ⁽¹⁾		AU9		
4	IO_L02P_4/D1		AV9		
4	IO_L03N_4/D2		AY9		
4	IO_L03P_4/D3		AW9		
4	IO_L05_4/No_Pair		AN11		
4	IO_L06N_4/VRP_4		AR10		
4	IO_L06P_4/VRN_4		AP10		
4	IO_L07N_4		AU10		
4	IO_L07P_4/VREF_4		AT10		
4	IO_L08N_4		AV10		
4	IO_L08P_4		AW10		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
4	IO_L09N_4		AR11		
4	IO_L09P_4/VREF_4		AP11		
4	IO_L19N_4		AV11		
4	IO_L19P_4		AU11		
4	IO_L20N_4		AY10		
4	IO_L20P_4		AY11		
4	IO_L21N_4		AN12		
4	IO_L21P_4		AM12		
4	IO_L25N_4		AR12		
4	IO_L25P_4		AP12		
4	IO_L26N_4		AT12		
4	IO_L26P_4		AU12		
4	IO_L27N_4		AW12		
4	IO_L27P_4/VREF_4		AV12		
4	IO_L28N_4		AM13		
4	IO_L28P_4		AL13		
4	IO_L29N_4		AP13		
4	IO_L29P_4		AN13		
4	IO_L30N_4		AT13		
4	IO_L30P_4		AR13		
4	IO_L34N_4		AV13		
4	IO_L34P_4		AU13		
4	IO_L35N_4		AW13		
4	IO_L35P_4		AY13		
4	IO_L36N_4		AL15		
4	IO_L36P_4/VREF_4		AL14		
4	IO_L78N_4		AN14	NC	
4	IO_L78P_4		AM14	NC	
4	IO_L83_4/No_Pair		AR14	NC	
4	IO_L84N_4		AU14	NC	
4	IO_L84P_4		AT14	NC	
4	IO_L85N_4		AW14	NC	
4	IO_L85P_4		AV14	NC	
4	IO_L86N_4		AM15	NC	
4	IO_L86P_4		AN15	NC	
4	IO_L87N_4		AR15	NC	

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCAUX		AM11		
N/A	VCCAUX		AN33		
N/A	VCCAUX		AN10		
N/A	VCCAUX		AV39		
N/A	VCCAUX		AV4		
N/A	VCCAUX		AW38		
N/A	VCCAUX		AW22		
N/A	VCCAUX		AW21		
N/A	VCCAUX		AW5		
N/A	VCCAUX		AA42		
N/A	VCCAUX		AA41		
N/A	VCCAUX		AA2		
N/A	VCCAUX		AA1		
N/A	VCCAUX		Y42		
N/A	VCCAUX		Y1		
N/A	VCCAUX		L32		
N/A	VCCAUX		L11		
N/A	VCCAUX		K33		
N/A	VCCAUX		K10		
N/A	VCCAUX		E39		
N/A	VCCAUX		E4		
N/A	VCCAUX		D38		
N/A	VCCAUX		D22		
N/A	VCCAUX		D21		
N/A	VCCAUX		D5		
N/A	GND		AB38		
N/A	GND		AB35		
N/A	GND		AB32		
N/A	GND		AB26		
N/A	GND		AB25		
N/A	GND		AB24		
N/A	GND		AB23		
N/A	GND		AB22		
N/A	GND		AB21		
N/A	GND		AB20		
N/A	GND		AB19		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
0	IO_L11N_0	M25	NC
0	IO_L11P_0	M26	NC
0	IO_L12N_0	F26	NC
0	IO_L12P_0	G26	NC
0	IO_L18N_0	B26	NC
0	IO_L18P_0/VREF_0	C26	NC
0	IO_L46N_0	G24	
0	IO_L46P_0	G25	
0	IO_L47N_0	K26	
0	IO_L47P_0	L26	
0	IO_L48N_0	E25	
0	IO_L48P_0	F25	
0	IO_L49N_0	C24	
0	IO_L49P_0	C25	
0	IO_L50_0/No_Pair	L24	
0	IO_L53_0/No_Pair	L25	
0	IO_L54N_0	A25	
0	IO_L54P_0	B25	
0	IO_L55N_0	H23	
0	IO_L55P_0	H24	
0	IO_L56N_0	J25	
0	IO_L56P_0	K25	
0	IO_L57N_0	E24	
0	IO_L57P_0/VREF_0	F24	
0	IO_L58N_0	D23	
0	IO_L58P_0	D24	
0	IO_L59N_0	J24	
0	IO_L59P_0	K24	
0	IO_L60N_0	A24	
0	IO_L60P_0	B24	
0	IO_L64N_0	F23	
0	IO_L64P_0	G23	
0	IO_L65N_0	M22	
0	IO_L65P_0	M23	
0	IO_L66N_0	B23	
0	IO_L66P_0/VREF_0	C23	
0	IO_L67N_0	H22	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	IO_L40P_2	R5	
2	IO_L41N_2	V6	
2	IO_L41P_2	V7	
2	IO_L42N_2	R3	
2	IO_L42P_2	P3	
2	IO_L43N_2	R1	
2	IO_L43P_2	R2	
2	IO_L44N_2	W10	
2	IO_L44P_2	W11	
2	IO_L45N_2	T7	
2	IO_L45P_2	R7	
2	IO_L46N_2/VREF_2	T4	
2	IO_L46P_2	T5	
2	IO_L47N_2	W9	
2	IO_L47P_2	Y10	
2	IO_L48N_2	T1	
2	IO_L48P_2	T2	
2	IO_L49N_2	U6	
2	IO_L49P_2	T6	
2	IO_L50N_2	W7	
2	IO_L50P_2	Y8	
2	IO_L51N_2	U4	
2	IO_L51P_2	T3	
2	IO_L52N_2/VREF_2	U2	
2	IO_L52P_2	U3	
2	IO_L53N_2	Y11	
2	IO_L53P_2	Y12	
2	IO_L54N_2	V4	
2	IO_L54P_2	V5	
2	IO_L55N_2	V1	
2	IO_L55P_2	V2	
2	IO_L56N_2	Y6	
2	IO_L56P_2	Y7	
2	IO_L57N_2	W5	
2	IO_L57P_2	W6	
2	IO_L58N_2/VREF_2	W3	
2	IO_L58P_2	V3	